

DUAL OP AMP AND VOLTAGE REFERENCE

AP4310/A

Pin Configuration

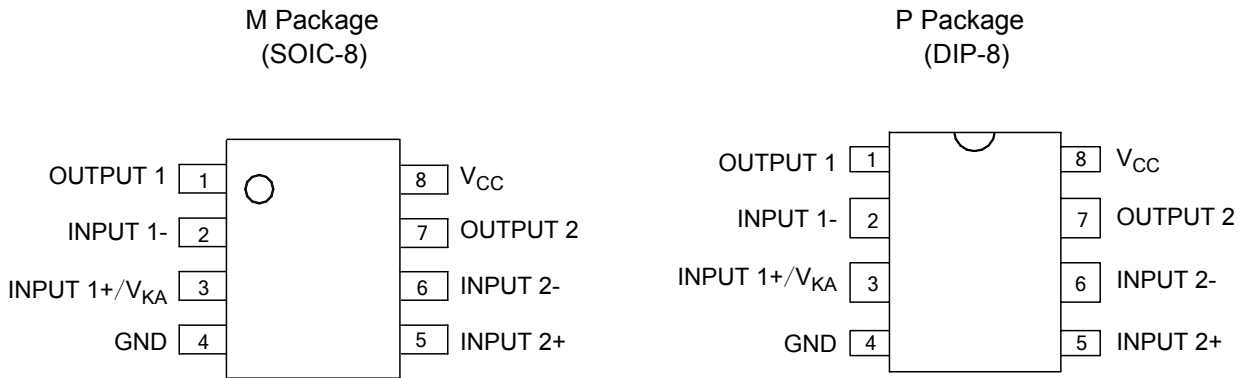


Figure 2. Pin Configuration of AP4310/A (Top View)

Functional Block Diagram

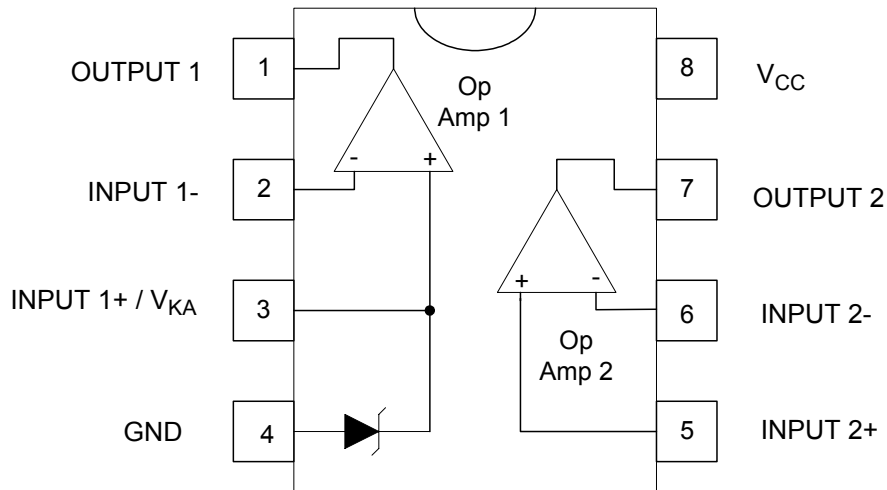


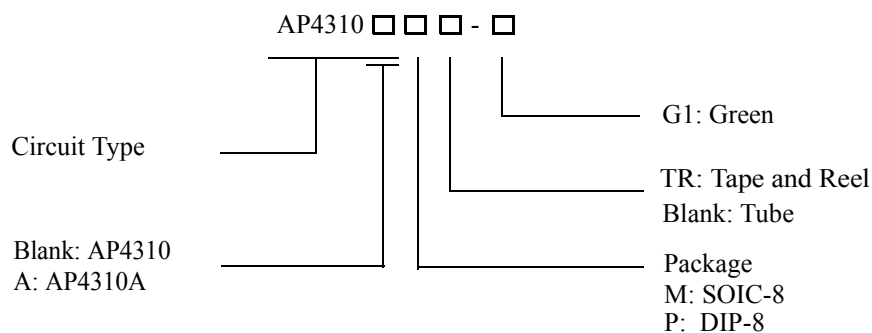
Figure 3. Functional Block Diagram of AP4310/A



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Ordering Information



Package	Reference Voltage	Voltage Tolerance	Temperature Range	Part Number	Marking ID	Packing Type
DIP-8	2.5V	± 0.4%	-40 to 105°C	AP4310AP-G1	AP4310AP-G1	Tube
		± 1%		AP4310P-G1	AP4310P-G1	
SOIC-8	2.5V	± 0.4%	-40 to 105°C	AP4310AM-G1	AP4310AM-G1	Tube
				AP4310AMTR-G1	AP4310AM-G1	Tape & Reel
		± 1%	-40 to 105°C	AP4310M-G1	AP4310M-G1	Tube
				AP4310MTR-G1	AP4310M-G1	Tape & Reel

BCD Semiconductor's products, as designated with "G1" suffix in the part number, are RoHS compliant and Green.

**DUAL OP AMP AND VOLTAGE REFERENCE****AP4310/A****Absolute Maximum Ratings (Note 1)**

Parameter	Symbol	Value	Unit	
Power Supply Voltage (V_{CC} to GND)	V_{CC}	40	V	
Op Amp 1 and 2 Input Voltage Range (Pins 2, 5, 6)	V_{IN}	-0.3 to $V_{CC}+0.3$	V	
Op Amp 2 Input Differential Voltage (Pins 5, 6)	V_{ID}	40	V	
Voltage Reference Cathode Current (Pin 3)	I_K	100	mA	
Power Dissipation ($T_A=25^{\circ}\text{C}$)	P_D	DIP-8	800	mW
		SOIC-8	500	
Operating Junction Temperature	T_J	150	$^{\circ}\text{C}$	
Storage Temperature Range	T_{STG}	-65 to 150	$^{\circ}\text{C}$	
Lead Temperature (Soldering 10s)	T_{LEAD}	260	$^{\circ}\text{C}$	
ESD (Human Body Model)	ESD	≥ 2000	V	

Note 1: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Recommended Operating Conditions

Parameter	Min	Max	Unit
Supply Voltage	3	36	V
Ambient Temperature	-40	105	$^{\circ}\text{C}$



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Electrical Characteristics

Operating Conditions: $V_{CC} = +5V$, $T_A = 25^\circ C$ unless otherwise specified.

Parameter	Conditions		Min	Typ	Max	Unit	
Total Supply Current, excluding Current in Voltage Reference	$V_{CC} = 5V$, no load, $-40^\circ C \leq T_A \leq 105^\circ C$			0.15	0.25	mA	
	$V_{CC} = 30V$, no load, $-40^\circ C \leq T_A \leq 105^\circ C$			0.20	0.30		
Voltage Reference Section							
Reference Voltage	AP4310A	$I_K = 10mA$	$T_A = 25^\circ C$	2.49	2.50	2.51	V
			$-40^\circ C \leq T_A \leq 105^\circ C$	2.48	2.50	2.52	
	AP4310		$T_A = 25^\circ C$	2.475	2.50	2.525	V
			$-40^\circ C \leq T_A \leq 105^\circ C$	2.45	2.50	2.55	
Reference Voltage Deviation Over Full Temperature Range	$I_K = 10mA$, $T_A = -40$ to $105^\circ C$			5	24	mV	
Minimum Cathode Current for Regulation				0.01	0.05	mA	
Dynamic Impedance	$I_K = 1.0$ to $80mA$, $f < 1kHz$			0.2	0.5	Ω	
Op Amp 1 Section ($V_{CC} = 5V$, $V_O = 1.4V$, $T_A = 25^\circ C$, unless otherwise noted)							
Input Offset Voltage	$T_A = 25^\circ C$			0.5	3	mV	
	$T_A = -40$ to $105^\circ C$				5		
Input Offset Voltage Temperature Drift	$T_A = -40$ to $105^\circ C$			7		$\mu V/^\circ C$	
Input Bias Current (Inverting Input Only)	$T_A = 25^\circ C$			20	150	nA	
Large Signal Voltage Gain	$V_{CC} = 15V$, $R_L = 2k\Omega$, $V_O = 1.4$ to $11.4V$		85	100		dB	
Power Supply Rejection Ratio	$V_{CC} = 5$ to $30V$		70	90		dB	
Output Current	Source	$V_{CC} = 15V$, $V_{ID} = 1V$, $V_O = 2V$	20	40		mA	
	Sink	$V_{CC} = 15V$, $V_{ID} = -1V$, $V_O = 2V$	5	20		mA	
Output Voltage Swing (High)	$V_{CC} = 30V$, $R_L = 10k\Omega$, $V_{ID} = 1V$		27	28		V	
Output Voltage Swing (Low)	$V_{CC} = 30V$, $R_L = 10k\Omega$, $V_{ID} = -1V$			17	100	mV	
Slew Rate	$V_{CC} = 18V$, $R_L = 2k\Omega$, $A_V = 1$, $V_{IN} = 0.5$ to $2V$, $C_L = 100pF$		0.2	0.5		$V/\mu s$	
Unity Gain Bandwidth	$V_{CC} = 30V$, $R_L = 2k\Omega$, $C_L = 100pF$		0.7	1.0		MHz	



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Electrical Characteristics (Continued)

Operating Conditions: $V_{CC}=+5V$, $T_A=25^{\circ}C$ unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Unit
Op Amp 2 Section ($V_{CC}=5V$, $V_O=1.4V$, $T_A=25^{\circ}C$, unless otherwise noted)					
Input Offset Voltage	$T_A=25^{\circ}C$		0.5	3	mV
	$T_A=-40$ to $105^{\circ}C$			5	
Input Offset Voltage Temperature Drift	$T_A=-40$ to $105^{\circ}C$		7		$\mu V/^{\circ}C$
Input Offset Current	$T_A=25^{\circ}C$		2	30	nA
Input Bias Current	$T_A=25^{\circ}C$		20	150	nA
Input Voltage Range	$V_{CC}=0$ to $36V$	0		$V_{CC}-1.5$	V
Common Mode Rejection Ratio	$T_A=25^{\circ}C$, $V_{CM}=0$ to $3.5V$	70	85		dB
Large Signal Voltage Gain	$V_{CC}=15V$, $R_L=2k\Omega$, $V_O=1.4$ to $11.4V$	85	100		dB
Power Supply Rejection Ratio	$V_{CC}=5$ to $30V$	70	90		dB
Output Current	Source $V_{CC}=15V$, $V_{ID}=1V$, $V_O=2V$	20	40		mA
	Sink $V_{CC}=15V$, $V_{ID}=-1V$, $V_O=2V$	5	20		mA
Output Voltage Swing (High)	$V_{CC}=30V$, $R_L=10k\Omega$, $V_{ID}=1V$	27	28		V
Output Voltage Swing (Low)	$V_{CC}=30V$, $R_L=10k\Omega$, $V_{ID}=-1V$		17	100	mV
Slew Rate	$V_{CC}=18V$, $R_L=2k\Omega$, $A_V=1$, $V_{IN}=0.5$ to $2V$, $C_L=100pF$	0.2	0.5		$V/\mu s$
Unity Gain Bandwidth	$V_{CC}=30V$, $R_L=2k\Omega$, $C_L=100pF$	0.7	1.0		MHz



Typical Performance Characteristics

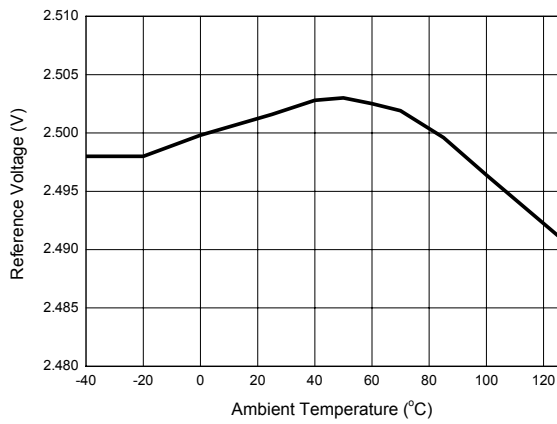


Figure 4. Reference Voltage vs. Ambient Temperature

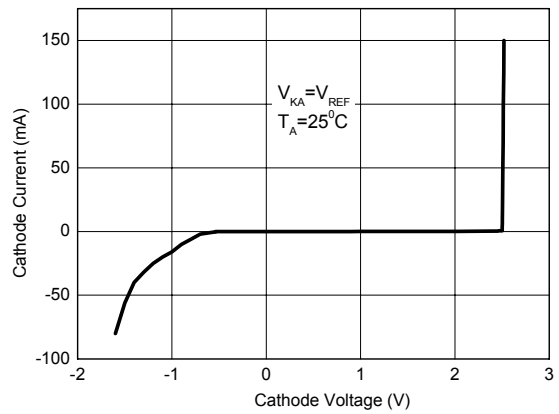


Figure 5. Cathode Current vs. Cathode Voltage

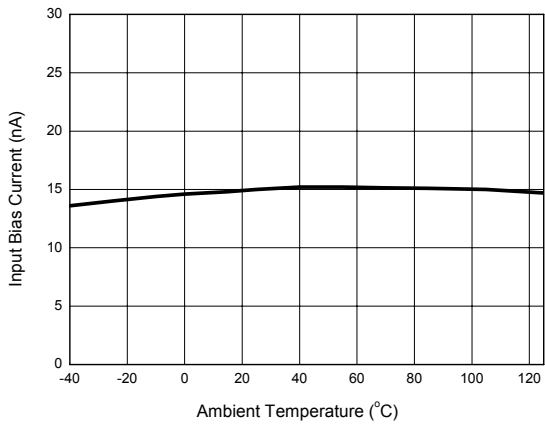


Figure 6. Input Bias Current vs. Ambient Temperature

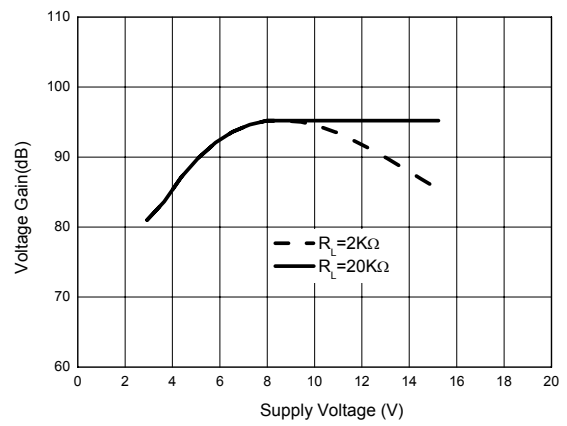


Figure 7. Op Amp Voltage Gain

Typical Application

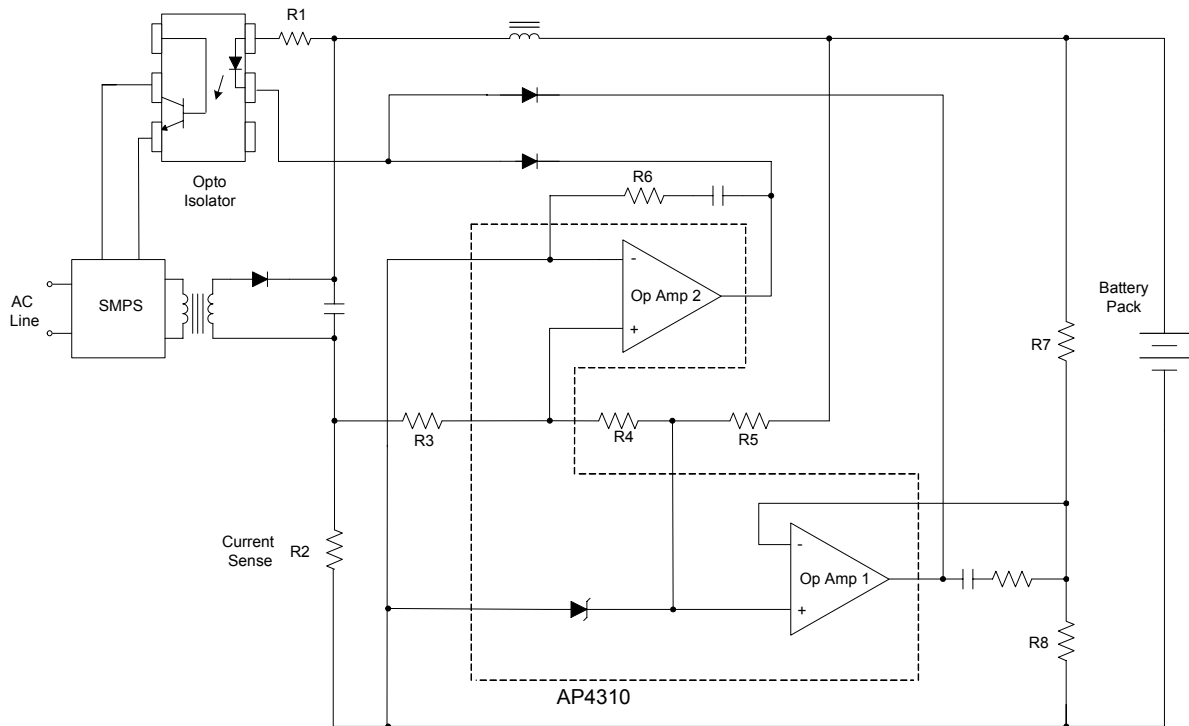


Figure 8. Application of AP4310/A in a Constant Current and Constant Voltage Charger

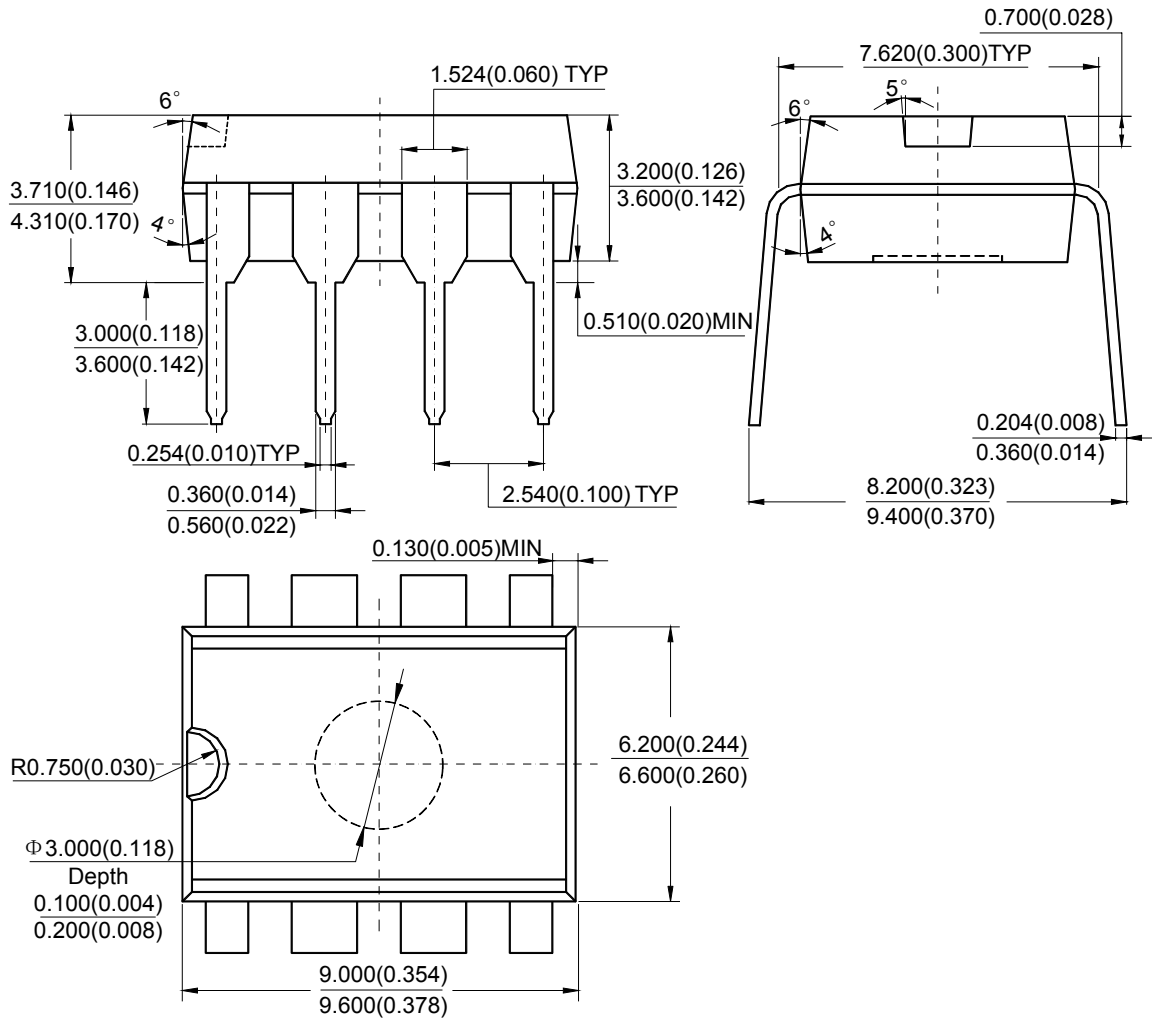
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Mechanical Dimensions

DIP-8

Unit: mm(inch)



Note: Eject hole, oriented hole and mold mark is optional.



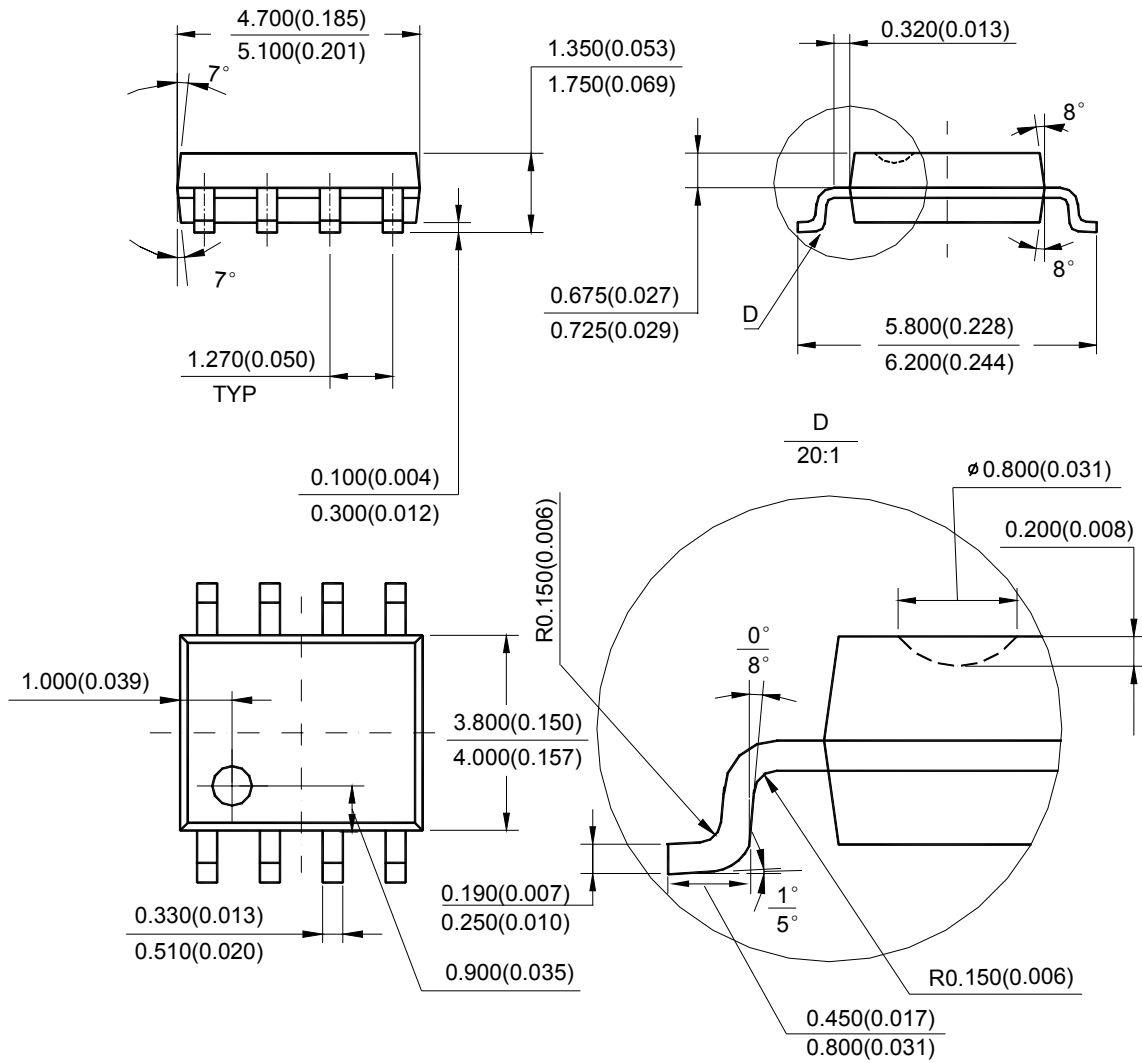
DUAL OP AMP AND VOLTAGE REFERENCE

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Mechanical Dimensions (Continued)

SOIC-8

Unit: mm(inch)



Note: Eject hole, oriented hole and mold mark is optional.



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